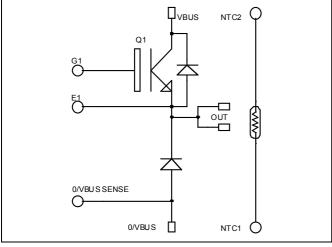
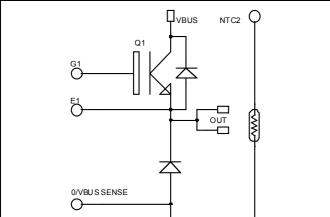


## **Buck** chopper Trench + Field Stop IGBT3 Power Module







#### **Application**

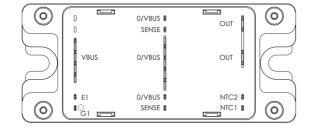
- AC and DC motor control
- Switched Mode Power Supplies

#### **Features**

- Trench + Field Stop IGBT3 Technology
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 20 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- High level of integration
- Internal thermistor for temperature monitoring

#### **Benefits**

- Stable temperature behavior
- Very rugged
  - Solderable terminals for easy PCB mounting
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- **RoHS Compliant**



### Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
$V_{CES}$	Collector - Emitter Breakdown Voltage		1700	V
T	Continuous Collector Current	$T_C = 25$ °C	150	
$I_{C}$	Continuous Conector Current	$T_C = 80$ °C	100	A
$I_{CM}$	Pulsed Collector Current	$T_C = 25^{\circ}C$	200	
$V_{GE}$	Gate – Emitter Voltage		±20	V
$P_{D}$	Maximum Power Dissipation	$T_C = 25$ °C	560	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 125$ °C	200A @ 1600V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



## All ratings @ $T_j = 25$ °C unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 1700V$				250	μΑ
V	Collector Emitter Saturation Voltage $V_{GE} = 15V$ $T_{J}$		$T_j = 25$ °C		2.0	2.4	V
$V_{CE(sat)}$	Conector Emitter Saturation Voltage	$I_{\rm C} = 100 A$	$T_j = 125$ °C		2.4		·
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 2mA$		5.0	5.8	6.5	V
$I_{GES}$	Gate – Emitter Leakage Current	$V_{GE} = 20V, V_{CE} = 0V$				400	nA

**Dynamic Characteristics** 

	Characteristic	Test Conditions		Min	Тур	Max	Unit
$C_{ies}$	Input Capacitance	$V_{GE} = 0V$			9		nF
$C_{oes}$	Output Capacitance	$V_{CE} = 25V$			0.36		
$C_{res}$	Reverse Transfer Capacitance	f = 1MHz			0.3		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (	25°C)		370		ns
$T_{r}$	Rise Time	$V_{GE} = 15V$			40		
T <sub>d(off)</sub>	Turn-off Delay Time	$V_{Bus} = 900V$ $I_{C} = 100A$			650		
$T_{\mathrm{f}}$	Fall Time	$R_G = 4.7 \Omega$			180		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C)			400		
$T_{r}$	Rise Time	$V_{GE} = 15V$			50		ns
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 900V$ $I_C = 100A$			800		
$T_{\mathrm{f}}$	Fall Time	$R_G = 4.7 \Omega$			300		
Eon	Turn-on Switching Energy	$V_{GE} = 15V$ $V_{Bus} = 900V$ $T_{j} = 15V$	= 125°C		32	·	m I
$\mathrm{E}_{\mathrm{off}}$	Turn-off Switching Energy	$\begin{bmatrix} I_C = 100A \\ R_G = 4.7 \Omega \end{bmatrix} T_j =$	= 125°C		31		mJ

Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit	
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage			1700			V	
$I_{RM}$	Maximum Reverse Leakage Current	$V_{R}=1700V$	$T_j = 25^{\circ}C$			250	μА	
1KM	Waximam Reverse Bearage Carrent	V R 1700 V	VR 1700 V	$T_j = 125$ °C			500	μ1
$I_{\mathrm{F}}$	DC Forward Current		$Tc = 80^{\circ}C$		100		A	
$V_{\mathrm{F}}$	Diode Forward Voltage	$I_{\rm F} = 100 A$	$T_j = 25^{\circ}C$		1.8	2.2	V	
<b>V</b> F	Blode I of ward Voluge	1 <sub>F</sub> 10071	$T_{i} = 125^{\circ}C$		1.9		•	
t <sub>rr</sub>	Reverse Recovery Time		$T_j = 25^{\circ}C$		385		ns	
чт	reverse recovery Time	1004	$T_j = 125$ °C		490		113	
0	Reverse Recovery Charge	$I_F = 100A$ $V_R = 900V$	$T_j = 25^{\circ}C$		25		μС	
$Q_{rr}$	Reverse Recovery Charge	$di/dt = 1000A/\mu s$	$T_j = 125$ °C		42		μС	
$E_{r}$	D	Povorce Pagavery Energy		$T_j = 25$ °C		11		mJ
$\mathbf{L}_{\mathrm{r}}$	Reverse Recovery Energy		$T_j = 125$ °C		21		1113	



Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

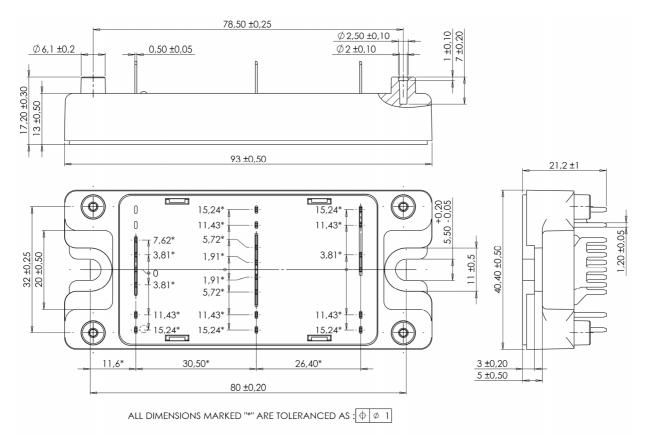
Symbol	Characteristic	Min	Тур	Max	Unit	
R <sub>25</sub>	Resistance @ 25°C		50		kΩ	ì
B 25/85	$T_{25} = 298.15 \text{ K}$		3952		K	i

$$R_{T} = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$
 
$$R_{T}: \text{ Thermistor value at T}$$

Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
$R_{thJC}$	Junction to Case Thermal Resistance		IGBT			0.22	°C/W
TthJC			Diode			0.39	C/ VV
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t =	1 min, 50/60Hz		4000			V
$T_{J}$	Operating junction temperature range		-40		150		
$T_{STG}$	Storage Temperature Range		-40		125	°C	
$T_{\rm C}$	Operating Case Temperature		-40		100		
Torque	Mounting torque	To Heatsink	M5	2.5		4.7	N.m
Wt	Package Weight					160	g

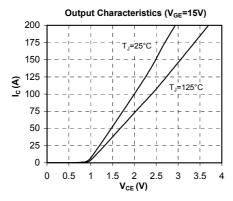
### SP4 Package outline (dimensions in mm)

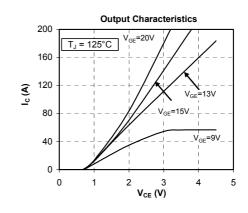


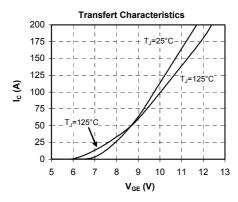
See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

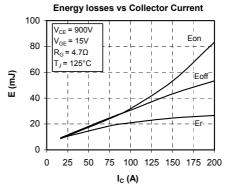


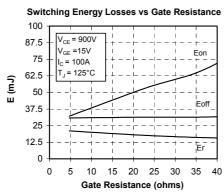
### **Typical Performance Curve**

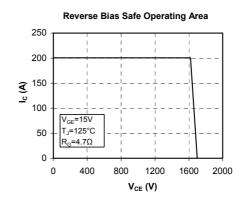


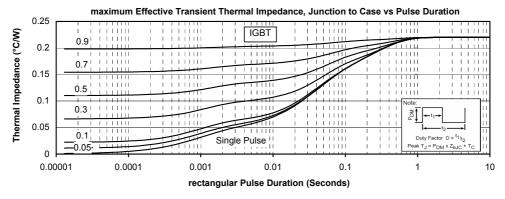




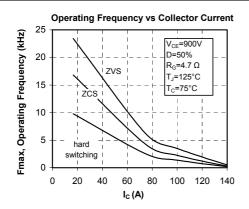


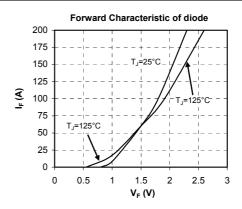


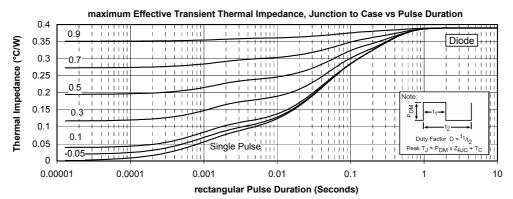












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FD300R12KS4\_B5 FD400R12KE3 FD400R33KF2C-K FD401R17KF6C\_B2 FD-DF80R12W1H3\_B52 FF100R12KS4 FF1200R17KE3\_B2
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